

BR93G66FV-3GTE2 Information


For Reference Only

Part Number [BR93G66FV-3GTE2](#)
Manufacturer Rohm Semiconductor
Category Integrated Circuits (ICs)
[Memory](#)
Description MICROWIRE BUS 4KBIT(256X16BIT) E
Package 8-TSSOP (0.173", 4.40mm Width)
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


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Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


BR93G66FV-3GTE2 Specifications

Manufacturer Part Number	BR93G66FV-3GTE2
Manufacturer	Rohm Semiconductor
Category	Integrated Circuits (ICs) Memory
Package	8-TSSOP (0.173", 4.40mm Width)
Series	-
Memory Type	Non-Volatile
Memory Format	EEPROM
Technology	EEPROM
Memory Size	4Kb (256 x 16)
Memory Interface	SPI
Clock Frequency	3MHz
Write Cycle Time - Word, Page	5ms
Access Time	-
Voltage - Supply	1.7 V ~ 5.5 V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	8-SSOPB

[Report errors?](#)

BR93G66FV-3GTE2 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

BR93G66FV-3GTE2 Payment Methods



BR93G66FV-3GTE2 Shipping Methods



If you have any question about BR93G66FV-3GTE2, please do not hesitate to contact us!

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